## **Special Issue**

## Bottom-up Approach and Self-Assembled Nano-Structures for Plasmonics and Nano-Optics Applications

## Message from the Guest Editors

In this Special Issue we would like to review all the different self-assembly techniques with their applications in the fields of Plasmonics and Nano-Optics from nanoantennas, light manipulation, sensors, bio-sensensors and so on. In addition, we would like to present new contributions with papers devoted to recent results in this promising and rich field, in order to take a look at future developments of bottom-up approach. If you feel that your contribution fit with the aim of this Special Issue, you are kindly invited to participate to this project.

## **Guest Editors**

Prof. Dr. Alessandro Belardini

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## Deadline for manuscript submissions

closed (20 November 2019)



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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

## Editor-in-Chief

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